



PATENT APPLICATION

#12/13
11/19/03
R1199

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re the Application of

Jun AMAKO et al.

Group Art Unit: 3721

Application No.: 09/801,699

Examiner: L. Huynh

Filed: March 9, 2001

Docket No.: 108850

For: PACKAGE SEALING METHOD, MANUFACTURING METHOD OF ELECTRONIC
DEVICE MODULES, SEALING APPARATUS, AND PACKAGED PRODUCT

RESPONSE TO QUAYLE ACTION

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RECEIVED

NOV 07 2003

TECHNOLOGY CENTER R3700

Sir:

In reply to the October 16, 2003 Office Action, please consider the following:

Amendments to the Claims as reflected in the listing of claims; and

Remarks.